

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>EIJI MUGIYA</td> <td>10/28/2013</td> </tr> <tr> <td>KENZO KITAZAKI</td> <td>10/29/2013</td> </tr> <tr> <td>MASAYA SHIMAMURA</td> <td>10/29/2013</td> </tr> </tbody> </table>		Name	Execution Date	EIJI MUGIYA	10/28/2013	KENZO KITAZAKI	10/29/2013	MASAYA SHIMAMURA	10/29/2013		
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<table border="1"> <tr> <td>Name:</td> <td>Taiyo Yuden Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>16-20, Ueno 6-chome, Taito-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>110-0005</td> </tr> </table>		Name:	Taiyo Yuden Co., Ltd.	Street Address:	16-20, Ueno 6-chome, Taito-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	110-0005
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CORRESPONDENCE DATA											
Fax Number:	(312)577-7007										
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ATTORNEY DOCKET NUMBER:	9881-131901-US										
NAME OF SUBMITTER:	STEPHEN S. FAVAKEH										
Signature:	/Stephen S. Favakeh/										

Date:	11/21/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 5</b> source=9881-131901Assignment#page1.tif source=9881-131901Assignment#page2.tif source=9881-131901Assignment#page3.tif source=9881-131901Assignment#page4.tif source=9881-131901Assignment#page5.tif	

**COMBINED DECLARATION FOR UTILITY OR DESIGN  
PATENT APPLICATION AND ASSIGNMENT THEREOF**

As a below named inventor, I hereby declare that:

The below-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

**CIRCUIT MODULE AND METHOD OF PRODUCING CIRCUIT MODULE**

*(Title of Invention)*

the specification of which:

- ☐ is attached hereto, or
- ☒ was filed by an authorized person on my behalf on November 21, 2013  
as United States Application Number or PCT International Application  
Number 14/086,472, and was amended on \_\_\_\_\_  
(if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the filing date of the continuation-in-part application.

I, for good and valuable consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign and sell, which confirms any previous assignment by me or by operation of law, to Taiyo Yuden Co., Ltd., a Japanese corporation, having its principal place of business at 16-20, Ueno 6-chome, Taito-ku, Tokyo, 110-0005 Japan

("Assignee"), its successors, assigns, and legal representatives, the entire right, title, and interest, in and to all subject matter and improvements invented, made, or conceived by me and described in the application for patent identified above and in and to all patent and all patent convention and treaty rights of all kinds, including the right to claim priority from said application, and all rights in and to any utility model, continuation, continuation-in-part, and divisional application therefrom, and any reissue or re-examination as to any patent issuing therefrom, in all countries throughout the world, for all such subject matter described therein, including all rights of action and rights to recover damages for past infringements.

I agree that on request and without further consideration, I will communicate to the Assignee or its representatives or nominees any facts known to me respecting the inventions and improvements and testify in any legal proceeding, make all rightful oaths, sign all lawful papers, and execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights in all countries including, but not limited to, any provisional, non-provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, for any derivation proceedings relating thereto, and, as to any patents that issue from such applications, for any supplemental examination, derivation proceeding, opposition, post grant review, reissue, re-examination, *inter partes* review, or extension thereof, and generally do everything possible to aid the Assignee, its successors, assigns, and nominees to obtain and enforce proper patent protection for the invention and its improvements in all countries.

I hereby authorize and request the attorneys of Fitch, Even, Tabin & Flannery, LLP to insert above the filing date and application number of said application when known.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made herein on information and belief are believed to be true.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Legal Name of Inventor:  
(Given names first, with Family name last)

Eiji MUGIYA

Inventor's Signature:

Eiji Mugiya

Date:

October 28, 2013

Inventor's Address:

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Tokyo, 110-0005 Japan

Legal Name of Inventor:  
(Given names first, with Family name last)

Kenzo KITAZAKI

Inventor's Signature:

Kenzo Kitezaki

Date:

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Tokyo, 110-0005 Japan

Legal Name of Inventor:  
(Given names first, with Family name last)

Masaya SHIMAMURA

Inventor's Signature:

Masaya Shimamura

Date:

October 29, 2013

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